

# N-Channel 100 V (D-S) MOSFET

D Q

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)			
100	0.114 at V <sub>GS</sub> = 10 V	15			

#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % Rg Tested
- Compliant to RoHS Directive 2002/95/EC

### **APPLICATIONS**

• Primary Side Switch

TO-252	G
L L G D S	N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	100	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20			
Continuous Drain Current (T. 475 °C)b	T <sub>C</sub> = 25 °C	1-	15			
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^b$	T <sub>C</sub> = 125 °C	I <sub>D</sub>	13			
Pulsed Drain Current		I <sub>DM</sub>	40	А		
Continuous Source Current (Diode Conduction)	۱ <sub>S</sub>	3				
Avalanche Current	I <sub>AS</sub>	3				
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	18	mJ		
	T <sub>C</sub> = 25 °C	P-	96 <sup>b</sup>	10/		
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 <sup>a</sup>			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 s	R <sub>thJA</sub>	15	18	°C/W	
Junction-to-Ambient <sup>a</sup>	Steady State		40	50		
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.85	1.1		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.

Drain-Source Breakdown Voltage

Gate Threshold Voltage

Parameter Static

**SPECIFICATIONS** (T<sub>J</sub> = 25 °C, unless otherwise

Symbol

V<sub>DS</sub> V<sub>GS(th)</sub>

				<sup>®</sup> VBsen Bsemi.co
ise noted)				
Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit
$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA	100			V
$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0		2.5	V
$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	
= 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	1		50	μA
= 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250	1
$V_{DS} = 5 V. V_{CS} = 10 V$	40			А

Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	μΑ	
	I <sub>DSS</sub>	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50		
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			250		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	40			А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.114			
Drain Courses On State Desistence	Brach	$V_{GS}$ = 10 V, I <sub>D</sub> = 3 A, T <sub>J</sub> = 125 °C		0.120		Ω	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS}$ = 10 V, I <sub>D</sub> = 3 A, T <sub>J</sub> = 175 °C		0.140			
		$V_{GS} = 4.5 \text{ V} \text{ I}_{D} = 3 \text{ A}$		0.120			
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3 A		35		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>			950			
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 25 V, F = 1 MHz		120		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			60			
Total Gate Charge <sup>c</sup>	Qg			24	41		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$		8		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			12			
Gate Resistance	R <sub>g</sub>		0.5		2.9	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	25		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 5.2 \Omega$		50	75	20	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 3 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 2.5 \Omega$		30	45	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>			60	90		
Source-Drain Diode Ratings and Char	acteristics (1	Γ <sub>C</sub> = 25 °C)					
Pulsed Current	I <sub>SM</sub>				5	А	
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = 3 A, V <sub>GS</sub> = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 3 A, dl/dt = 100 A/μs		180	250	ns	

Notes:

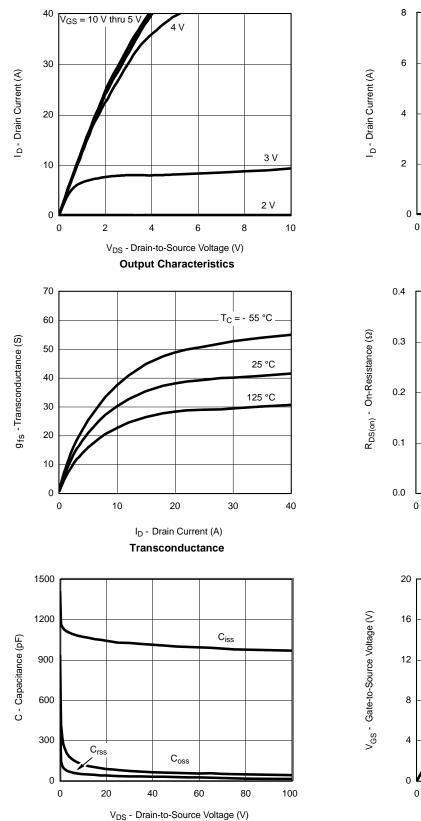
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. Independent of operating temperature.

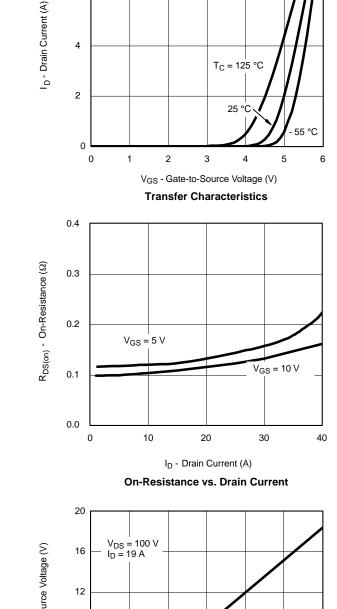
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





Capacitance

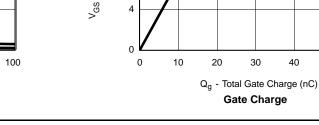
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



30

40

50



60

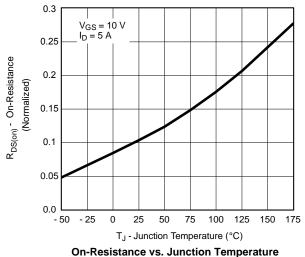


T<sub>J</sub> = 25 °C

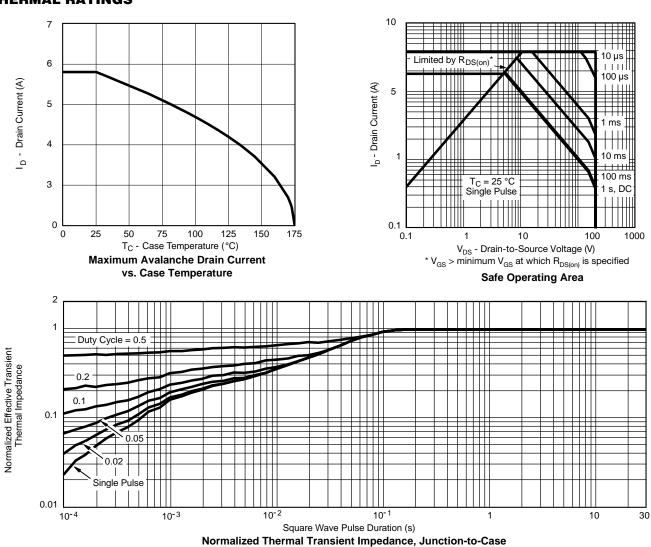
0.9

1.2

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







100

10

1

0

0.3

T<sub>J</sub> = 150 °C

0.6

Source-Drain Diode Forward Voltage

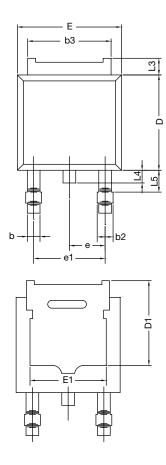
V<sub>SD</sub> - Source-to-Drain Voltage (V)

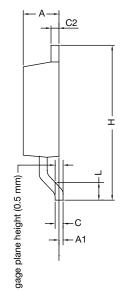
I<sub>S</sub> - Source Current (A)

### **IRFR120ZTRPBF**



# **TO-252AA CASE OUTLINE**





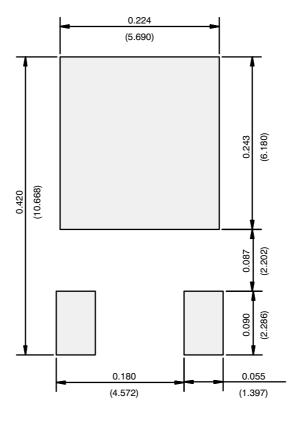
	MILLIN	METERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)



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